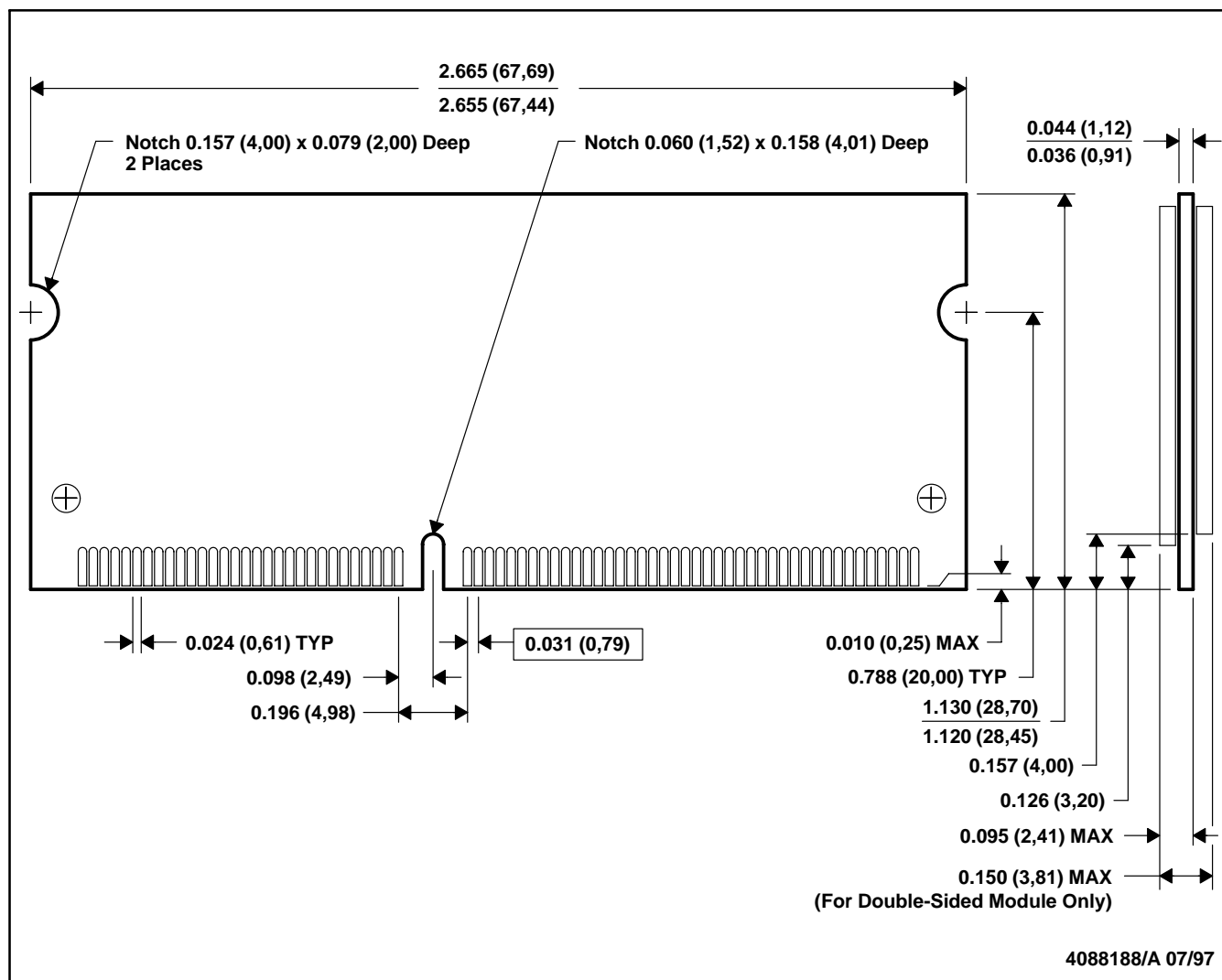


## BDQ (R-SODIMM-N144)

## SMALL OUTLINE DUAL IN-LINE MEMORY MODULE



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MO-190

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